

# AI TECHNOLOGY INC 70 Washington Road

Princeton Jct., NJ 08550 (609) 799-9388 fax (609) 799-9308

E-Mail: ait@aitechnology.com Internet: http://www.aitechnology.com

Flexible Epoxy Adhesive
High Thermal Conductivity
2-Component, Premixed Frozen
Stress-Free Bonding and
Reworkable

# **IDEAL FOR:**

**High Power Die and Component Attach** 

**Substrate Attach** 

**Heatsink Attach** 

Large Area Bonding

**Bonding Adherends with Mismatched CTE's** 

#### **DESCRIPTION:**

EG7658 is a reworkable, aluminum nitride filled, electrically insulating and thermally conductive epoxy paste adhesive. It which exhibits outstanding flexibility for bonding materials with highly mismatched CTE's (ie., alumina to aluminum, silicon to copper). The high thermal conductivity and flexibility make it excellent for bonding high-powered, large area die and components.

EG7658 can be reworked using temperatures higher than the cure temperature from 80-150°C to soften the bond line . Use a tool adequate to break the bond and remove. Clean any residue with a solvent which will not damage the parts. Caution: AIN under high humidity and temperature may cause corrosion to copper or other non-noble metal.

#### **AVAILABILITY:**

EG7658 is available in syringes for automatic needle dispense applications or in jars. Upon request, the material can be shipped premixed and frozen.

#### **APPLICATION PROCEDURES:**

- (1) Store Part A and Part B at ambient. Part A has higher vicosity.
- (  $\bf 2$  ) Mix A and B 1:1 by weight.
- (3) Cure according to one of the recommended cure schedules.

# PRIMA-BOND EG7658

# **TYPICAL PROPERTIES\***

Electrical Resistivity >1x10 14 ohm-cm

( 150 °C/ 60 minutes )

Dielectric Strength (Volts/mil) > 750 Glass Transition Temp.(°C) -25 ±10%

Current Carrying Capabilities NA

Lap-Shear Strength >1000 psi

>6.9 N/mm<sup>2</sup>

Device Push-off Strength >1

>1800 psi >12.4 N/mm<sup>2</sup>

Cured Density (gm/cc) 2.3 ±10% Thermal Conductivity 25 Btu-in

25 Btu-in/hr-ft2-oF ±10%

3.6 W/m-°C ±10%

**Linear Thermal Expansion** 

120

Coeff. (ppm/°C)

Maximum Continuous Operation Temp. (°C) <150

Avg. Viscosity(0.5 rpm, 25°C) 290,000 cp ±20% (Brookfield DV-1, Spindle CP51)

\* Properties given are typical values and not intended for use in preparing specifications. The user is advised to evaluate the product in the manner the product is intended to be used in manufacturing and in the final product.

## \*\*CURE SCHEDULES:

<u>Temperature</u>	<u>Time</u>
80°C	8 hr
100°C	4 hr
125°C	2 hr
150°C	1 hr

<sup>\*\*</sup>If material is premixed and frozen, thaw for 30 minutes, apply and cure according to one of the recommended cure schedules.

### **SHELF LIFE:**

Storage temperature	Shelf Life
25°C	***1 \r

CAUTION: This product may cause skin irritation. Avoid skin contact. If contact does occur, wash immediately with soap and water. Please refer SDS for more details.

The information contained herein is believed to be reliable. All recommendations or suggestions are made without guarantee inasmuch as conditions and methods of commercial use are beyond our control. Properties given are typical values and not intended for use in preparing specifications. The user is advised to evaluate the product in the manner the product is to be used in manufacturing and in the final product. Under no circumstance shall Al Technology be liable for accidental, consequential or other damages arising from the use or handling of this product.

While AI Technology owns all proprietary rights of material formulations of its products, specific usage in the manufacturing of certain products may involve patent rights of other companies.

PRODUCT DATA SHEET Ver 2.0 4/2/2018

<sup>\*\*\*</sup>Shelf life is for unmixed components. If premixed: -40°C for 6 months. After mixing, pot life is 4 hours at 25°C.